Document Number: 93363 Revision: 31-May-11

Vishay Semiconductors

GA400TD60S

Dual INT-A-PAK Low Profile "Half-Bridge" (Standard Speed IGBT), 400 A



- Generation 4 IGBT technology
- Standard: Optimized for hard switching speed DC to 1 kHz COMPLIANT
- Low V_{CE(on)}
- Square RBSOA
- HEXFRED[®] antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al₂O₃ DBC
- UL approved file E78996
- Compliant to RoHS Directive 2002/95/EC
- Designed for industrial level

BENEFITS

- Increased operating efficiency
- Performance optimized as output inverter stage for TIG welding machines
- Direct mounting on heatsink
- · Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		600	V		
Continuous collector current	Ic ⁽¹⁾	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	750			
	IC ()	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	525			
Pulsed collector current	I _{CM}		1000	А		
Clamped inductive load current	I _{LM}		1000	A		
Diode continuous forward current		$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	219			
	I _F	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	145			
Gate to emitter voltage	V _{GE}		± 20	V		
Maximum power dissipation (IGBT)	Р	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	1563	w		
	PD	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	875	vv		
RMS isolation voltage	V _{ISOL}	Any terminal to case (V _{RMS} t = 1 s, T _J = 25 °C)	3500	V		

Note

⁽¹⁾ Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals







Dual INT-A-PAK Low Profile

600 V

750 A

1.24 V

PRODUCT SUMMARY

VCES

 I_C DC at T_C = 25 °C

V_{CE(on)} (typical) at 400 A, 25 °C

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 500 \mu\text{A}$	600	-	-	
	V _{CE(on)}	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 300 \text{ A}$	-	1.14	1.35	V
Collector to emitter voltage		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 400 \text{ A}$	-	1.24	1.52	
		V_{GE} = 15 V, I_C = 300 A, T_J = 125 $^\circ C$	-	1.08	1.29	
		V_{GE} = 15 V, I_C = 400 A, T_J = 125 °C	-	1.21	1.5	
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 250 \ \mu A$	3.0	4.6	6.3	
Collector to emitter leakage current	I _{CES}	$V_{GE} = 0 V, V_{CE} = 600 V$	-	0.075	1	
		$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 600 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	1.8	10	mA
		I _{FM} = 300 A	-	1.48	1.75	
Diode forward voltage drop	N/		1.63	1.98	N	
	V _{FM}	I _{FM} = 300 A, T _J = 125 °C	-	1.50	1.77	V
		I _{FM} = 400 A, T _J = 125 °C	-	1.70	2.04	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 200	nA

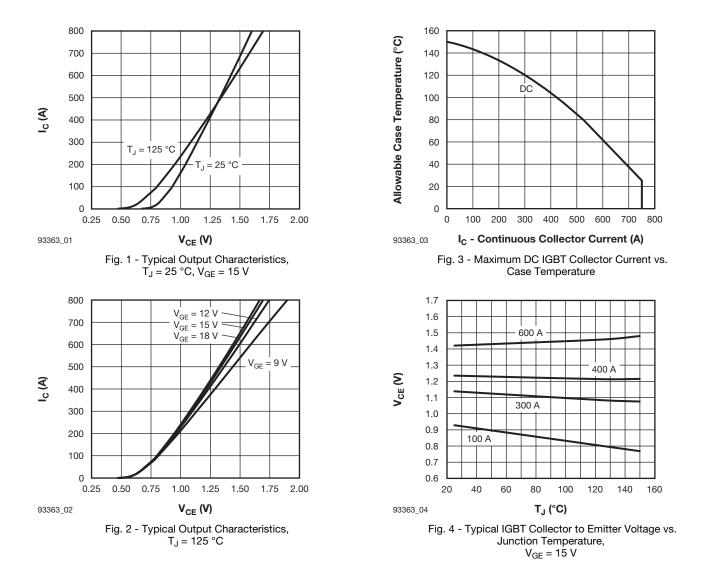
SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Turn-on switching loss	E _{on}		-	8.5	-		
Turn-off switching loss	E _{off}	I _C = 400 A, V _{CC} = 360 V, V _{GE} = 15 V, R _g = 1.5 Ω, L = 500 μH, T _J = 25 °C	-	113	-		
Total switching loss	E _{tot}	ng = 1.0 11, 2 = 000 p. 1, 13 = 20 0	-	121.5	-		
Turn-on switching loss	Eon		-	21	-	mJ	
Turn-off switching loss	E _{off}		-	163	-		
Total switching loss	E _{tot}		-	184	-		
Turn-on delay time	t _{d(on)}	I_{C} = 400 A, V _{CC} = 360 V, V _{GE} = 15 V, R _q = 1.5 Ω, L = 500 µH, T _J = 125 °C	-	532	-		
Rise time	t _r	ng = 1.0 11, 2 = 000 p.n, 1j = 120 0	-	377	-		
Turn-off delay time	t _{d(off)}		-	496	-	ns	
Fall time	t _f		-	1303	-		
Reverse bias safe operating area	RBSOA	$ \begin{array}{l} T_J = 150 \ ^\circ C, \ I_C = 1000 \ A, \ V_{CC} = 400 \ V, \\ V_P = 600 \ V, \ R_g = 22 \ \Omega, \ V_{GE} = 15 \ V \ to \ 0 \ V, \\ L = 500 \ \mu H \end{array} $ Fullsquare					
Diode reverse recovery time	t _{rr}		-	150	179	ns	
Diode peak reverse current	I _{rr}	I _F = 300 A, dI _F /dt = 500 A/μs, V _{CC} = 400 V, T _J = 25 °C	-	43	59	А	
Diode recovery charge	Q _{rr}	V() = 400 V, 19 = 20 C	-	3.9	6.3	μC	
Diode reverse recovery time	t _{rr}		-	236	265	ns	
Diode peak reverse current	I _{rr}	l _F = 300 A, dl _F /dt = 500 A/μs, V _{CC} = 400 V, T _L = 125 °C	-	64	80	А	
Diode recovery charge	Q _{rr}		-	8.6	11.1	μC	



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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Operating junction and storage temperature range		T _J , T _{Stg}	- 40	-	150	°C	
lumetion to one on lon		D	-	-	0.08		
Junction to case per leg	Diode	R _{thJC}	-	-	0.4	°C/W	
Case to sink per module		R _{thCS}	-	0.05	-		
Mounting torque	case to heatsink: M6 screw		4	-	6	Nim	
Mounting torque	ase to terminal 1, 2, 3: M5 screw		2	-	4	Nm	
Weight			-	270	-	g	





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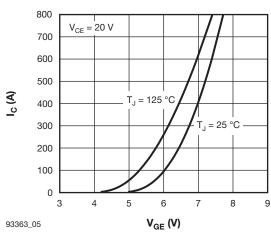
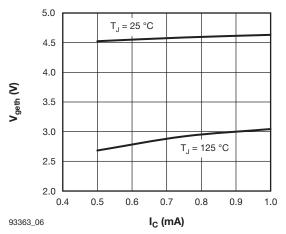
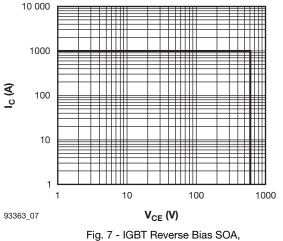
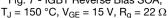


Fig. 5 - Typical IGBT Transfer Characteristics









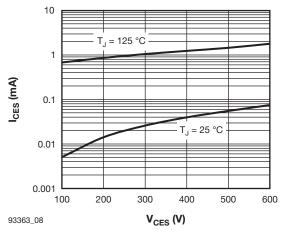
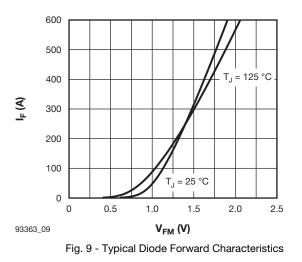
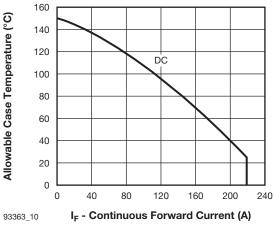
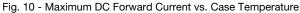


Fig. 8 - Typical IGBT Zero Gate Voltage Collector Current



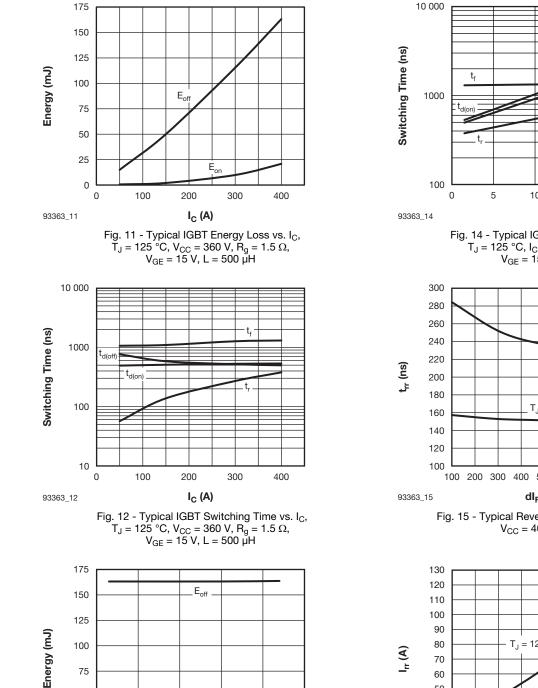


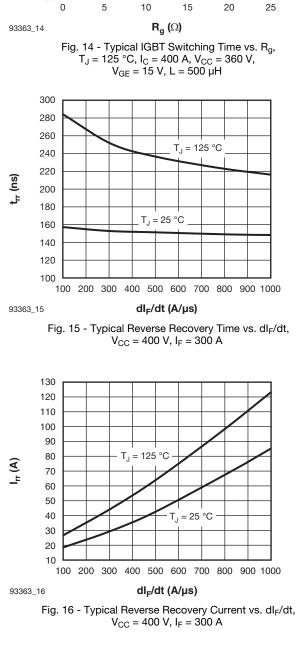


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75

50

25

0

93363_13

0

E_{on}

R_g (Ω)

Fig. 13 - Typical IGBT Energy Loss vs. Rg,

 $T_J = 125 \text{ °C}, I_C = 400 \text{ A}, V_{CC} = 360 \text{ V}, V_{GE} = 15 \text{ V}, L = 500 \,\mu\text{H}$

15

20

25

10

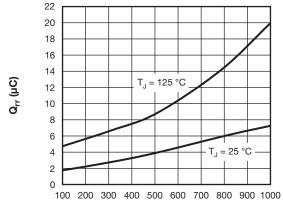
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For technical questions, contact: indmodules@vishay.com

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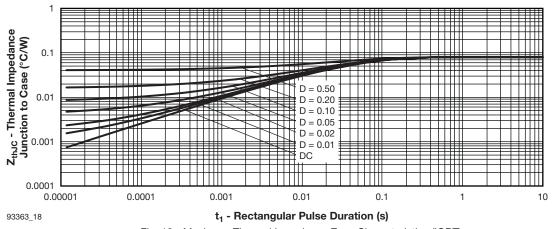




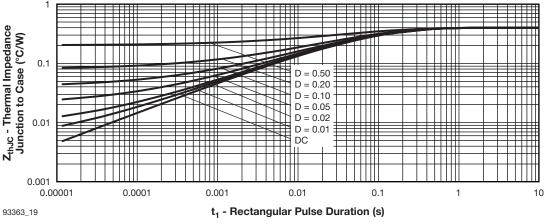
dl_F/dt (A/µs)

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Fig. 17 - Typical Reverse Recovery Charge vs. dl_F/dt, $V_{CC} = 400 \text{ V}, I_F = 300 \text{ A}$









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ORDERING INFORMATION TABLE

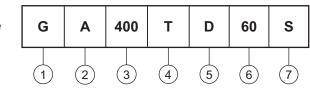
Device code

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3

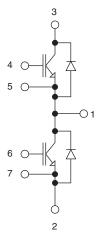
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5



- Insulated Gate Bipolar Transistor (IGBT) -
- 2 A = Generation 4 IGBT
 - Current rating (400 = 400 A)
 - Circuit configuration (T = Half-bridge)
 - Package indicator (D = Dual INT-A-PAK Low Profile) -
- 6 Voltage rating (60 = 600 V)-
- 7 Speed/type (S = Standard Speed IGBT)

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95435			



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